Overvoltage Protection Controller

FEATURES

- **2.5V to 5.5V Operation**
- **Overvoltage Protection Up to 80V**
- **No Input Capacitor or TVS Required for Most Applications**
- **2% Accurate 5.8V Overvoltage Threshold**
- **Controls N-Channel MOSFET**
- **<1µs Overvoltage Turn-Off, Gentle Shutdown**
- Adjustable Power-Up dV/dt Limits Inrush
- Reverse Voltage Protection (LTC4360-2)
- Power Good Output
- Low Current Shutdown (LTC4360-1)
- Available in a Tiny 8-Lead SC70 Package

APPLICATIONS

- USB Protection
- Handheld Computers
- Cell/Smart Phones
- MP3/MP4 Players
- Digital Cameras

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DESCRIPTION

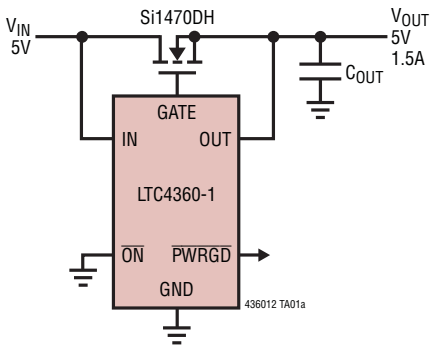
The LTC®4360 overvoltage protection controller safeguards 2.5V to 5.5V systems from power supply overvoltage. It is designed for portable devices with multiple power supply options including wall adaptors, car battery adaptors and USB ports.

The LTC4360 controls an external N-channel MOSFET in series with the input power supply. During overvoltage transients, the LTC4360 turns off the MOSFET within 1µs, isolating downstream components from the input supply. Inductive cable transients are absorbed by the MOSFET and load capacitance. In most applications, the LTC4360 provides protection from transients up to 80V without requiring transient voltage suppressors or other external components.

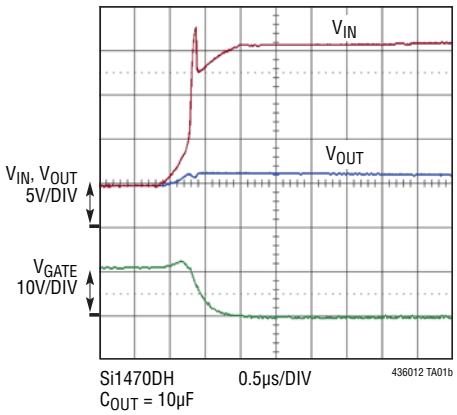
The LTC4360 has a delayed start-up and an adjustable dV/dt ramp-up for inrush current limiting. A $\overline{\text{PWRGD}}$ pin provides power good monitoring for V_{IN}. Following an overvoltage condition, the LTC4360 automatically restarts with a start-up delay. The LTC4360-1 features a soft shutdown controlled by the $\overline{\text{ON}}$ pin, while the LTC4360-2 controls an optional external P-channel MOSFET for negative voltage protection.

TYPICAL APPLICATION

Protection from Overvoltage



Output Protected from Overvoltage at Input



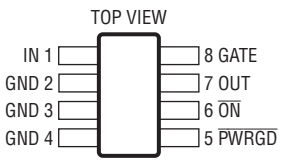
ABSOLUTE MAXIMUM RATINGS

(Notes 1, 2)

Bias Supply Voltage (IN) ..... –0.3V to 85V
Input Voltages
  OUT, $\overline{ON}$ ..... –0.3V to 9V
Output Voltages
  $\overline{PWRGD}$ ..... –0.3V to 9V
  GATE (Note 3) ..... –0.3V to 15V
  GATEP ..... –0.3V to 85V
  IN to GATEP ..... –0.3V to 10V
Operating Temperature Range
  LTC4360C ..... 0°C to 70°C
  LTC4360I ..... –40°C to 85°C
Storage Temperature Range ..... –65°C to 150°C
Lead Temperature (Soldering, 10 sec) ..... 300°C

PIN CONFIGURATION

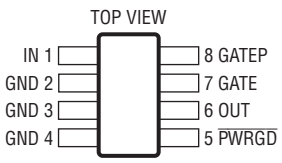
LTC4360-1



SC8 PACKAGE
8-LEAD PLASTIC SC70

T_{JMAX} = 125°C, θ_{JA} = 270°C/W

LTC4360-2



SC8 PACKAGE
8-LEAD PLASTIC SC70

T_{JMAX} = 125°C, θ_{JA} = 270°C/W

ORDER INFORMATION

Lead Free Finish

TAPE AND REEL (MINI)	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LTC4360CSC8-1#TRMPBF	LTC4360CSC8-1#TRPBF	LDXN	8-Lead Plastic SC70	0°C to 70°C
LTC4360CSC8-2#TRMPBF	LTC4360CSC8-2#TRPBF	LDXP	8-Lead Plastic SC70	0°C to 70°C
LTC4360ISC8-1#TRMPBF	LTC4360ISC8-1#TRPBF	LDXN	8-Lead Plastic SC70	–40°C to 85°C
LTC4360ISC8-2#TRMPBF	LTC4360ISC8-2#TRPBF	LDXP	8-Lead Plastic SC70	–40°C to 85°C

TRM = 500 pieces. *Temperature grades are identified by a label on the shipping container.

Consult LTC Marketing for parts specified with wider operating temperature ranges.
Consult LTC Marketing for information on lead based finish parts.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/
For more information on tape and reel specifications, go to: http://www.linear.com/tapeandreel/

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{IN} = 5V, $V_{\overline{ON}}$ = 0V (LTC4360-1) unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Supplies							
V_{IN}	Input Voltage Range		●	2.5		80	V
$V_{IN(UVL)}$	Input Undervoltage Lockout	V_{IN} Rising	●	1.8	2.1	2.45	V
I_{IN}	Input Supply Current	LTC4360-1 $V_{\overline{ON}}$ = 0V, LTC4360-2	●		220	400	µA
		LTC4360-1 $V_{\overline{ON}}$ = 2.5V	●		1.5	10	µA
Thresholds							
$V_{IN(OV)}$	IN Pin Overvoltage Threshold	V_{IN} Rising	●	5.684	5.8	5.916	V
ΔV_{OV}	Overvoltage Hysteresis		●	25	100	200	mV
External Gate Drive							
ΔV_{GATE}	External N-Channel MOSFET Gate Drive ($V_{GATE} - V_{OUT}$)	2.5V ≤ V_{IN} < 3V, I_{GATE} = –1µA 3V ≤ V_{IN} < 5.5V, I_{GATE} = –1µA	● ●	3.5 4.5	4.5 6	6 7.9	V V
$V_{GATE(TH)}$	GATE High Threshold for $\overline{PWRGD}$ Status	V_{IN} = 3.3V V_{IN} = 5V	● ●	5.7 6.7	6.3 7.2	6.8 7.8	V V
$I_{GATE(UP)}$	GATE Pull-Up Current	V_{GATE} = 1V	●	–5	–10	–15	µA
$V_{GATE(UP)}$	GATE Ramp-Up	V_{GATE} = 1V to 7V	●	1.5	3	4.5	V/ms
$I_{GATE(FST)}$	GATE Fast Pull-Down Current	Fast Turn-Off, V_{IN} = 6V, V_{GATE} = 9V	●	15	30	60	mA
$I_{GATE(DN)}$	GATE Pull-Down Current	$V_{\overline{ON}}$ = 2.5V, V_{GATE} = 9V (LTC4360-1)	●	10	40	80	µA
Input Pins							
$I_{OUT(IN)}$	OUT Input Current	V_{OUT} = 5V, $V_{\overline{ON}}$ = 0V V_{OUT} = 5V, $V_{\overline{ON}}$ = 2.5V	● ●	5	10 0	20 ±3	µA µA
$V_{\overline{ON}(TH)}$	$\overline{ON}$ Input Threshold	(LTC4360-1)	●	0.4		1.5	V
$I_{\overline{ON}}$	$\overline{ON}$ Pull-Down Current	$V_{\overline{ON}}$ = 2.5V (LTC4360-1)	●	2.5	5	10	µA
Output Pins							
$V_{GATEP(CLP)}$	IN to GATEP Clamp Voltage	(LTC4360-2)	●	5	5.8	7.5	V
R_{GATEP}	GATEP Resistive Pull-down	V_{GATEP} = 3V (LTC4360-2)	●	0.8	2	3.2	MΩ
$V_{\overline{PWRGD}(OL)}$	$\overline{PWRGD}$ Output Low Voltage	V_{IN} = 5V, $I_{\overline{PWRGD}}$ = 3mA	●		0.23	0.4	V
$R_{\overline{PWRGD}}$	$\overline{PWRGD}$ Pull-Up Resistance to OUT	V_{IN} = 6.5V, $V_{\overline{PWRGD}}$ = 1V	●	250	500	800	kΩ
Delay							
t_{ON}	GATE On Delay	V_{IN} High to I_{GATE} = –5µA	●	50	130	200	ms
t_{OFF}	GATE Off Propagation Delay	V_{IN} = Step 5V to 6.5V	●		0.25	1	µs
$t_{\overline{PWRGD}}$	$\overline{PWRGD}$ Delay	V_{IN} = Step 5V to 6.5V V_{GATE} > $V_{GATE(TH)}$ to $\overline{PWRGD}$ Low	● ●	 25	0.25 65	1 100	µs ms
$t_{\overline{ON}(OFF)}$	$\overline{ON}$ High to GATE Off	$V_{\overline{ON}}$ = Step 0V to 2.5V (LTC4360-1)	●		2	5	µs

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

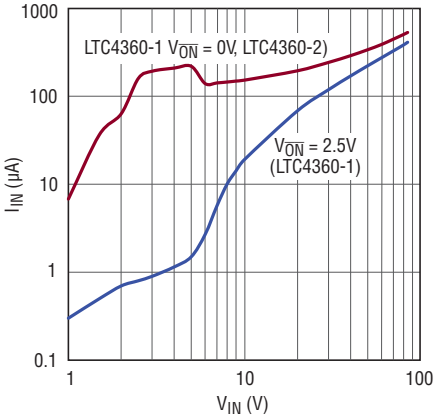
Note 2: All currents into device pins are positive; all currents out of device pins are negative. All voltages are referenced to GND unless otherwise specified.

Note 3: An internal clamp limits V_{GATE} to a minimum of 4.5V above V_{OUT}. Driving this pin to voltages beyond this clamp may damage the device.

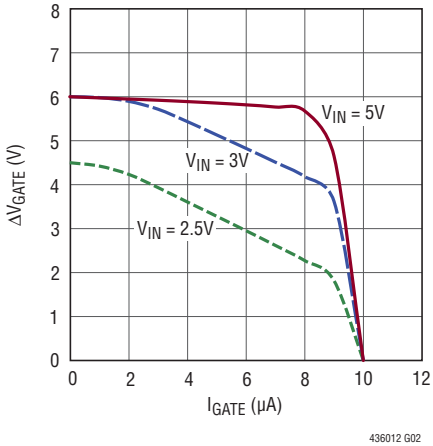
TYPICAL PERFORMANCE CHARACTERISTICS

T_A = 25°C, V_{IN} = 5V, $V_{\overline{ON}}$ = 0V (LTC4360-1) unless otherwise noted.

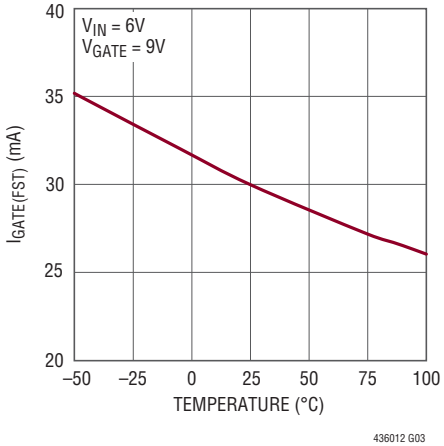
Input Supply Current vs Input Voltage



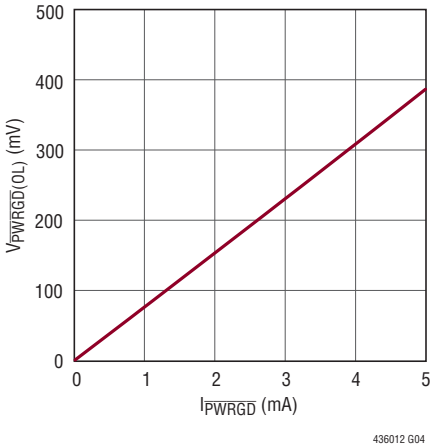
GATE Drive vs GATE Current



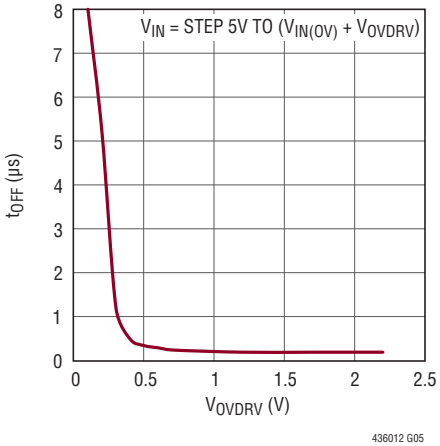
GATE Fast Pull-Down Current vs Temperature



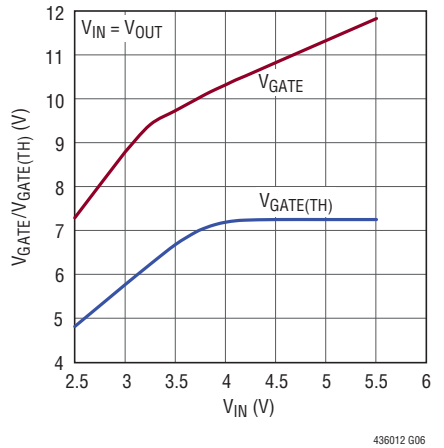
$\overline{PWRGD}$ Voltage vs $\overline{PWRGD}$ Current



GATE Off Propagation Delay vs Overdrive (V_{OVDRV})



GATE Voltage and GATE High Threshold (for $\overline{PWRGD}$ Status) vs Input Voltage



Normal Start-Up Sequence

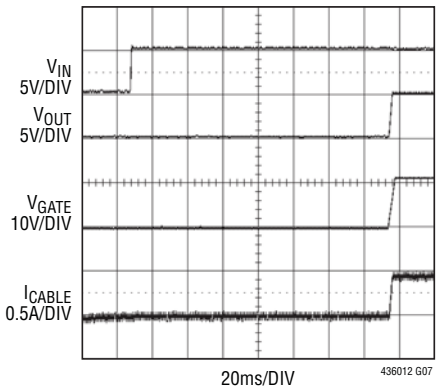


FIGURE 5 CIRCUIT
R_{IN} = 150mΩ, L_{IN} = 0.7µH
LOAD = 10Ω, C_{OUT} = 10µF

GATE Slow Ramp-Up

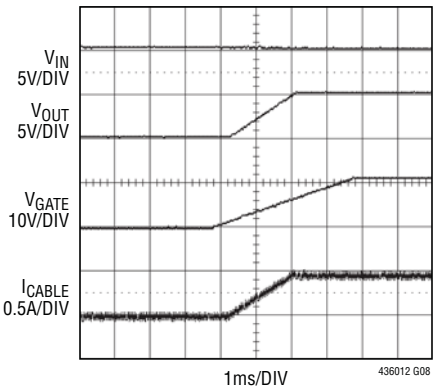


FIGURE 5 CIRCUIT
R_{IN} = 150mΩ, L_{IN} = 0.7µH
LOAD = 10Ω, C_{OUT} = 10µF

Entering Sleep Mode (LTC4360-1)

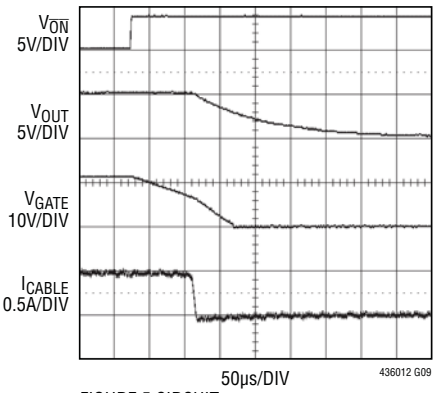


FIGURE 5 CIRCUIT
R_{IN} = 150mΩ, L_{IN} = 0.7µH
LOAD = 10Ω, C_{OUT} = 10µF

PIN FUNCTIONS

GATE: Gate Drive for External N-Channel MOSFET. An internal charge pump provides a 10µA pull-up current to charge the gate of the external N-channel MOSFET. An additional ramp circuit limits the GATE ramp rate when turning on to 3V/ms. For slower ramp rates, connect an external capacitor from GATE to GND. An internal clamp limits GATE to 6V above the OUT pin voltage. An internal GATE high comparator controls the $\overline{\text{PWRGD}}$ pin.

GATEP (LTC4360-2): Gate Drive for External P-Channel MOSFET. GATEP connects to the gate of an optional external P-channel MOSFET to protect against negative voltages at IN. This pin is internally clamped to 5.8V below V_{IN}. An internal 2M resistor connects this pin to ground. Connect to IN if not used.

GND: Device Ground.

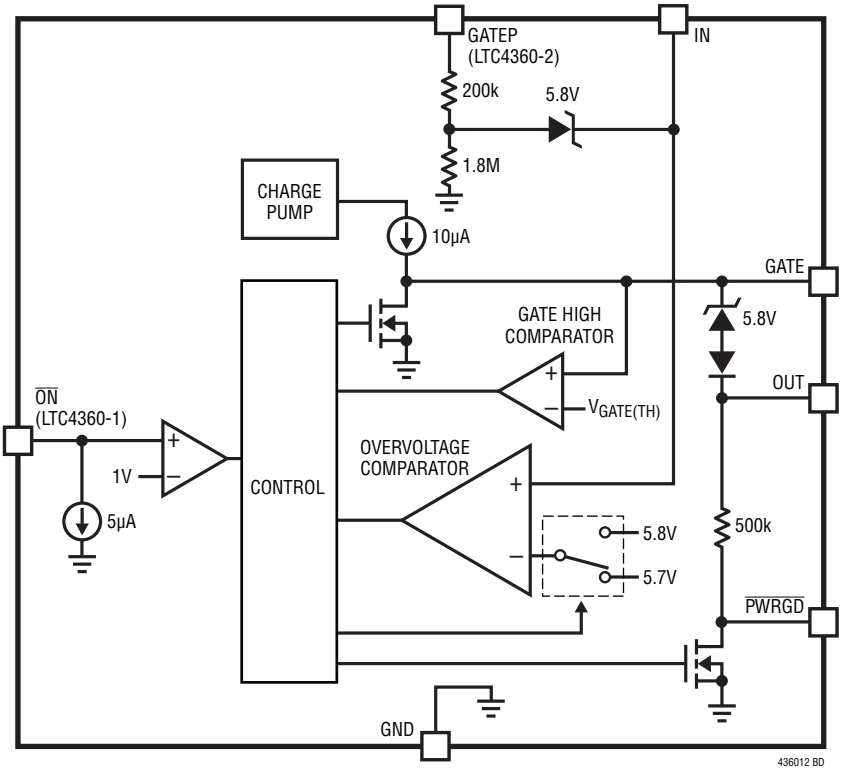
IN: Supply Voltage Input. Connect this pin to the input power supply. This pin has an overvoltage threshold of 5.8V. After an overvoltage event, this pin must fall below $V_{IN(OV)} - \Delta V_{OV}$ to release the overvoltage lockout. During lockout, GATE is held low and the $\overline{\text{PWRGD}}$ pull-down releases.

$\overline{\text{ON}}$ (LTC4360-1): On Control Input. A logic low at $\overline{\text{ON}}$ enables the LTC4360-1. A logic high at $\overline{\text{ON}}$ activates a low current pull-down at the GATE pin and causes the LTC4360-1 to enter a low current sleep mode. An internal 5µA current pulls $\overline{\text{ON}}$ down to ground. Connect to ground or leave open if unused.

OUT: Output Voltage Sense Input for Gate Clamp. Connect to the source of the external N-channel MOSFET to sense the output voltage for GATE to OUT clamp.

$\overline{\text{PWRGD}}$: Power Good Status. Open-drain output with internal 500k resistive pull-up to OUT. Pulls low 65ms after GATE ramps above $V_{GATE(TH)}$.

BLOCK DIAGRAM



OPERATION

Mobile devices like cell phones and MP3/MP4 players have highly integrated subsystems fabricated from deep submicron CMOS processes. The small form factor is accompanied by low absolute maximum voltage ratings. The sensitive electronics are susceptible to damage from transient or DC overvoltage conditions from the power supply.

Failures or faults in the power adaptor can cause an overvoltage event. So can hot-plugging an AC adaptor into the power input of the mobile device (see LTC Application Note 88). Today's mobile devices derive their power supply or recharge their internal batteries from multiple alternative inputs like AC wall adaptors, car battery adaptors and USB ports. A user may unknowingly plug in the wrong adaptor, damaging the device with a high or even a negative power supply voltage.

The LTC4360 protects low voltage electronics from these overvoltage conditions by controlling a low cost external N-channel MOSFET configured as a pass transistor. At power-up (V_{IN} > 2.1V), a start-up delay cycle begins. Any overvoltage condition causes the delay cycle to continue until a safe voltage is present. When the delay cycle completes, an internal high side switch driver slowly ramps up the MOSFET gate, powering up the output at a controlled rate and limiting the inrush current to the output capacitor.

If the voltage at the IN pin exceeds 5.8V ($V_{IN(OV)}$), GATE is pulled low quickly to protect the load. The incoming power supply must remain below 5.7V ($V_{IN(OV)} - \Delta V_{OV}$) for the duration of the start-up delay to restart the GATE ramp-up.

The LTC4360-1 has a CMOS compatible $\overline{ON}$ input. When driven low, the part is enabled. When driven high, the external N-channel MOSFET is turned off and the supply current of the LTC4360-1 drops to 1.5µA. The $\overline{PWRGD}$ pull-down releases during this low current sleep mode, UVLO or overvoltage and the subsequent 130ms start-up delay. After the start-up delay, GATE starts its slow ramp-up and ramps higher than $V_{GATE(TH)}$ to trigger a 65ms delay cycle. When that completes, $\overline{PWRGD}$ pulls low. The LTC4360-2 has a GATEP pin that drives an optional external P-channel MOSFET to provide protection against negative voltages at IN.

APPLICATIONS INFORMATION

The typical LTC4360 application protects 2.5V to 5.5V systems in portable devices from power supply overvoltage. The basic application circuit is shown in Figure 1. Device operation and external component selection is discussed in detail in the following sections.

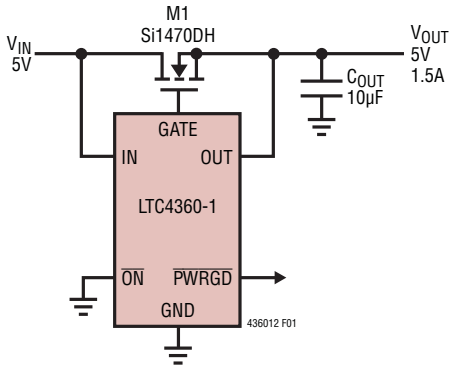


Figure 1. Protection from Input Overvoltage

Start-Up

When V_{IN} is less than the undervoltage lockout level of 2.1V, the GATE driver is held low and the $\overline{PWRGD}$ pull-down is high impedance. When V_{IN} rises above 2.1V and $\overline{ON}$ (LTC4360-1) is held low, a 130ms delay cycle starts. Any undervoltage or overvoltage event at IN (V_{IN} < 2.1V or V_{IN} > 5.7V) restarts the delay cycle. This delay allows the N-channel MOSFET to isolate the output from any input transients that occur at start-up. When the delay cycle completes, GATE starts its slow ramp-up.

GATE Control

An internal charge pump enhances the external MOSFET with 6V from GATE to OUT. This allows the use of logic-level N-channel MOSFETs. An internal 6V clamp between GATE and OUT protects the MOSFET gate.

APPLICATIONS INFORMATION

The GATE ramp rate is limited to 3V/ms. V_{OUT} follows at a similar rate which results in an inrush current into the load capacitor C_{OUT} of:

$$I_{INRUSH} = C_{OUT} \bullet \frac{dV_{GATE}}{dt} = C_{OUT} \bullet 3\ [mA/\mu F]$$

The servo loop is compensated by the parasitic capacitance of the external MOSFET. No further compensation components are normally required. In the case where the parasitic capacitance is less than 100pF, a 100pF compensation capacitor between GATE and ground may be required.

An even slower GATE ramp and lower inrush current can be achieved by connecting an external capacitor, C_G, from GATE to ground. The voltage at GATE then ramps up with a slope equal to $10\mu A/C_G$ [V/s]. Choose C_G using the formula:

$$C_G = \frac{10\mu A}{I_{INRUSH}} \bullet C_{OUT}$$

Overvoltage

When power is first applied, V_{IN} must remain below 5.7V ($V_{IN(OV)} - \Delta V_{OV}$) for more than 130ms before GATE is ramped up to turn on the MOSFET. If V_{IN} then rises above 5.8V ($V_{IN(OV)}$), the overvoltage comparator activates the 30mA fast pull-down on GATE within 1µs. After an overvoltage condition, the MOSFET is held off until V_{IN} once again remains below 5.7V for 130ms.

$\overline{PWRGD}$ Output

$\overline{PWRGD}$ is an active low output with a MOSFET pull-down to ground and a 500k resistive pull-up to OUT. The $\overline{PWRGD}$ pin pull-down releases during the low current sleep mode (invoked by $\overline{ON}$ high), UVLO or overvoltage and the subsequent 130ms start-up delay. After the start-up delay, GATE starts its slow ramp-up and control of the $\overline{PWRGD}$ pull-down passes on to the GATE high comparator. $V_{GATE} > V_{GATE(TH)}$ for more than 65ms asserts the $\overline{PWRGD}$ pull-down and $V_{GATE} < V_{GATE(TH)}$ releases the pull-down. The $\overline{PWRGD}$ pull-down is capable of sinking up to 3mA of current allowing it to drive an optional LED. To interface $\overline{PWRGD}$ to another I/O rail, connect a resistor from $\overline{PWRGD}$ to the I/O rail with a resistance low enough to override the internal 500k pull-up to OUT. Figure 2 details $\overline{PWRGD}$ behavior for a LTC4360-1 with 1k pull-up to 5V at $\overline{PWRGD}$.

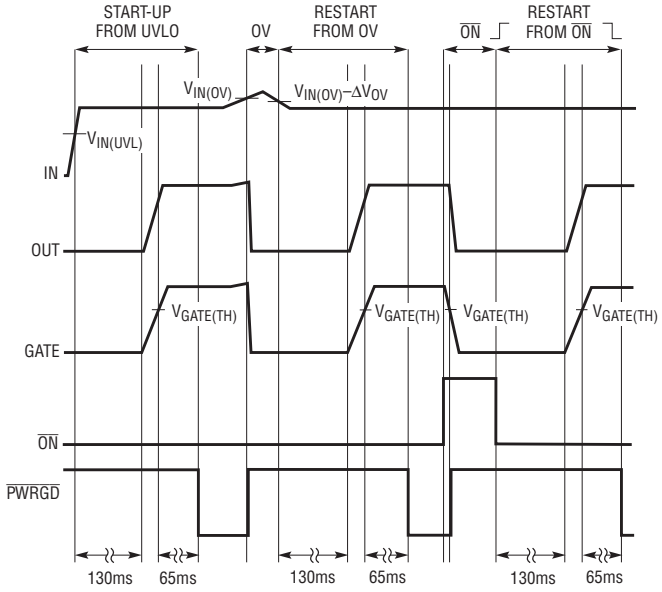


Figure 2. $\overline{PWRGD}$ Behavior

$\overline{ON}$ Input (LTC4360-1)

$\overline{ON}$ is a CMOS compatible, active low enable input. It has a default 5µA pull-down to ground. Connect this pin to ground or leave open to enable normal device operation. If it is driven high while the external MOSFET is turned on, GATE is pulled low with a weak pull-down current (40µA) to turn off the external MOSFET gradually, minimizing input voltage transients. The LTC4360-1 then goes into a low current sleep mode, drawing only 1.5µA at IN. When $\overline{ON}$ goes back low, the part restarts with a 130ms delay cycle.

GATEP Control (LTC4360-2)

GATEP has a 2M resistive pull-down to ground and a 5.8V Zener clamp in series with a 200k resistor to IN. It controls the gate of an optional external P-channel MOSFET to provide negative voltage protection. The 2M resistive pull-down turns on the MOSFET once $V_{IN} - V_{GATEP}$ is more than the MOSFET gate threshold voltage. The IN to GATEP Zener protects the MOSFET from gate overvoltage by clamping its V_{GS} to 5.8V when V_{IN} goes high.

APPLICATIONS INFORMATION

MOSFET Configurations and Selection

The LTC4360 can be used with various external MOSFET configurations (see Figure 3). The simplest configuration is a single N-channel MOSFET. It has the lowest $R_{DS(ON)}$ and voltage drop and is thus the most power efficient solution. When GATE is pulled to ground, the MOSFET can isolate OUT from a positive voltage at IN up to the BV_{DSS} of the MOSFET. However, reverse current can still flow from OUT to IN via the parasitic body diode of the MOSFET.

For near zero reverse leakage current protection when GATE is pulled to ground, back-to-back N-channel MOSFETs can be used. Adding an additional P-channel MOSFET controlled by GATEP (LTC4360-2) provides negative input voltage protection down to the BV_{DSS} of the P-channel MOSFET. Another configuration consists of a P-channel MOSFET controlled by GATEP and a N-channel MOSFET controlled by GATE. This provides protection against overvoltage and negative voltage but not reverse current.

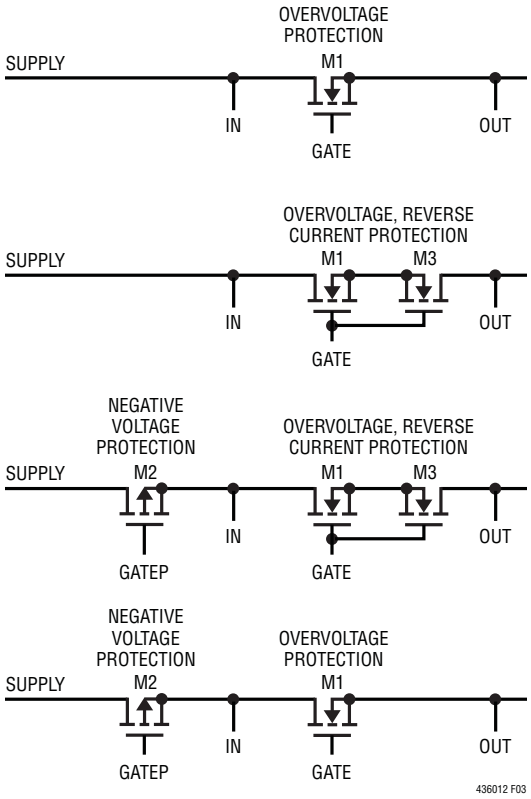
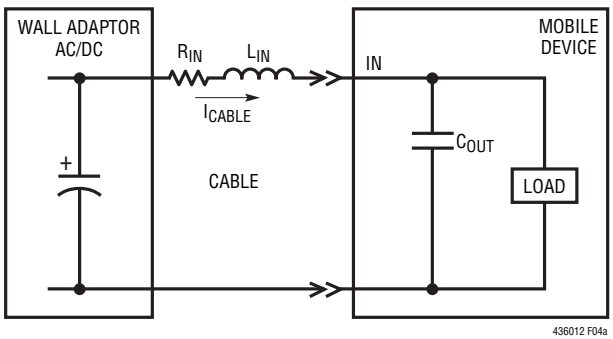


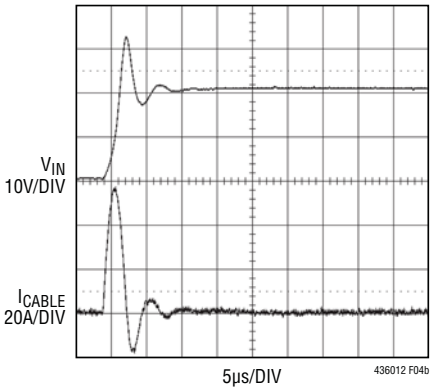
Figure 3. MOSFET Configurations

Input Transients

Figure 4 shows a typical setup when an AC wall adaptor charges a mobile device. The inductor L_{IN} represents the lumped equivalent inductance of the cable and the EMI filter found in some wall adaptors. R_{IN} is the lumped equivalent resistance of the cable, adaptor output capacitor ESR and the connector contact resistance.

L_{IN} and R_{IN} form an LC tank circuit with any capacitance at IN. If the wall adaptor is powered up first, plugging the wall adaptor output to IN does the equivalent of applying a voltage step to this LC circuit. The resultant voltage overshoot at IN can rise to twice the DC output voltage of the wall adaptor as shown in Figure 4. Figure 5 shows the 20V adaptor output applied to the LTC4360. Due to the low capacitance at the IN pin, the plug-in transient has been brought down to a manageable level.

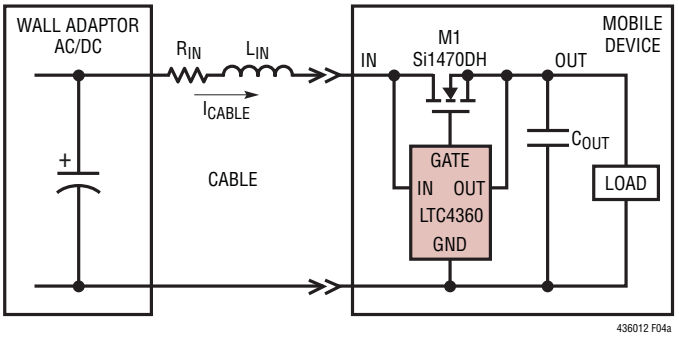


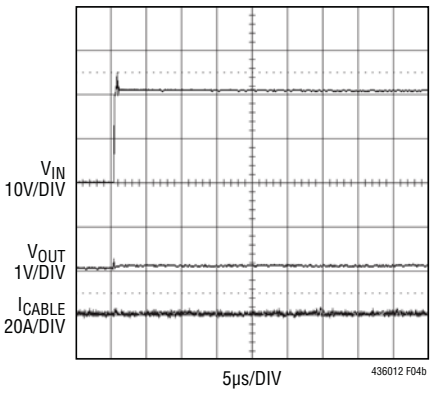


R_{IN} = 150mΩ, L_{IN} = 0.7µH
LOAD = 10Ω, C_{OUT} = 10µF

Figure 4. 20V Hot-Plug into a 10µF Capacitor

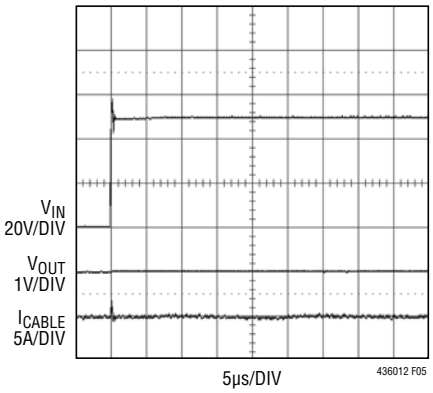
APPLICATIONS INFORMATION





RIN = 150mΩ, LIN = 0.7µH
LOAD = 10Ω, COUT = 10µF

Figure 5. 20V Hot-Plug into the LTC4360



FDC5612
RIN = 150mΩ, LIN = 0.7µH
LOAD = 10Ω, COUT = 10µF

Figure 6. 50V Hot-Plug into the LTC4360

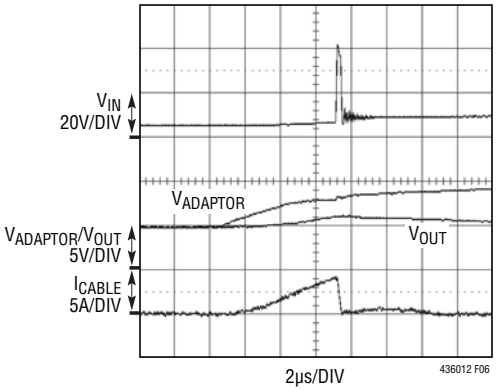


FIGURE 5 CIRCUIT
RIN = 150µΩ, LIN = 2µH
LOAD = 10Ω, COUT = 10µF

Figure 7. Input Transient After Overvoltage

As the IN pin can withstand up to 80V, a high voltage N-channel MOSFET can be used to protect the system against rugged abuse from high transient or DC voltages up to the BV_{DSS} of the MOSFET. Figure 6 shows a 50V input plugged into the LTC4360 controlling a 60V rated MOSFET.

Input transients also occur when the current through the cable inductance changes abruptly. This can happen when the LTC4360 turns off the N-channel MOSFET rapidly in an overvoltage event. Figure 7 shows the effects of a voltage transient at the wall adaptor output $V_{ADAPTOR}$. The current in L_{IN} will cause V_{IN} to overshoot and avalanche the N-channel MOSFET to C_{OUT}. Typically, IN will be clamped to a voltage of V_{OUT} + 1.3•(BV_{DSS} of Si1470DH) = 45V. This is well below the 85V absolute maximum voltage rating of the LTC4360. The single, nonrepetitive, pulse of energy (E_{AS}) absorbed by the MOSFET during this avalanche breakdown with a peak current I_{AS} is approximated by the formula:

$$E_{AS} = 0.5 \bullet L_{IN} \bullet I_{AS}^2$$

For L_{IN} = 2µH and I_{AS} = 4A, then E_{AS} = 16µJ. This is within the I_{AS} and E_{AS} capabilities of most MOSFET's including the Si1470DH. So in most instances, the LTC4360 can ride through such transients without a bypass capacitor, transient voltage suppressor or other external components at IN.

APPLICATIONS INFORMATION

Figure 8 shows a particularly severe situation which can occur in a mobile device with dual power inputs. A 20V wall adaptor is mistakenly hot-plugged into the 5V device with the USB input already live. As shown in Figure 9, a large current can build up in L_{IN} to charge up C_{OUT}. When the N-channel MOSFET shuts off, the energy stored in L_{IN} is dumped into C_{OUT}, causing a large 40V input transient. The LTC4360 limits this to a 1V rise in the output voltage.

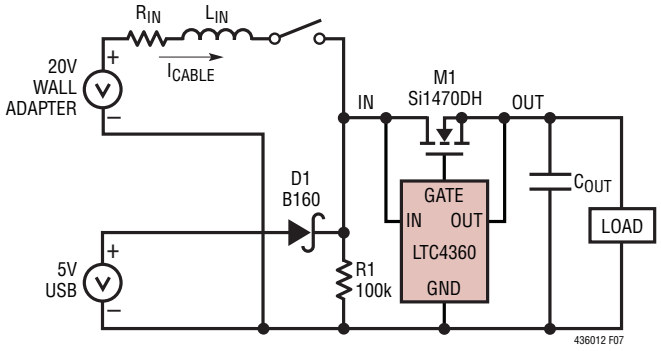


Figure 8. Setup for Testing 20V Plugged into 5V System

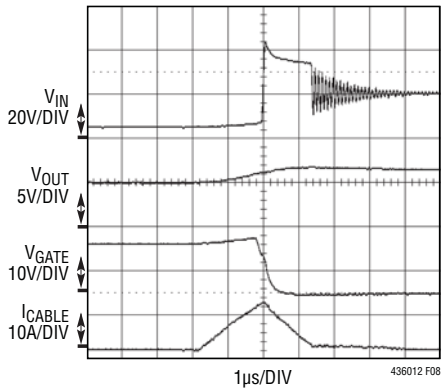


FIGURE 8 CIRCUIT
R_{IN} = 150mΩ, L_{IN} = 2µH
LOAD = 10Ω, C_{OUT} = 10µF (16V, SIZE 1210)

Figure 9. Overvoltage Protection Waveforms When 20V Plugged into 5V System

If the voltage rise at V_{OUT} due to the discharge of the energy in L_{IN} into C_{OUT} is not acceptable or the avalanche capability of the MOSFET is exceeded, an additional external clamp such as the SMAJ24A can be placed between IN and GND. C_{OUT} is the decoupling capacitor of the protected circuits and its value will largely be determined by their requirements. Using a larger C_{OUT} will work with L_{IN} to slow down the dV/dt at OUT, allowing time for the LTC4360 to shut off the MOSFET before V_{OUT} overshoots to a dangerous voltage. A larger C_{OUT} also helps to lower the ΔV_{OUT} due to the discharge of the energy in L_{IN} if the MOSFET BV_{DSS} is used as an input clamp.

Layout Considerations

Figure 10 shows example PCB layouts for the single N-channel MOSFET (SC70 package) configuration and the P-channel MOSFET/N-channel MOSFET (Complementary P, N MOSFET in TSOP-6 package) configuration. Keep the traces to the MOSFETs wide and short. The PCB traces associated with the power path through the MOSFETs should have low resistance.

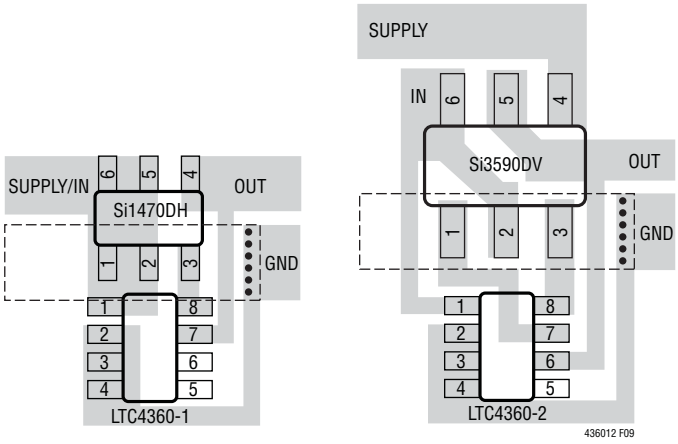
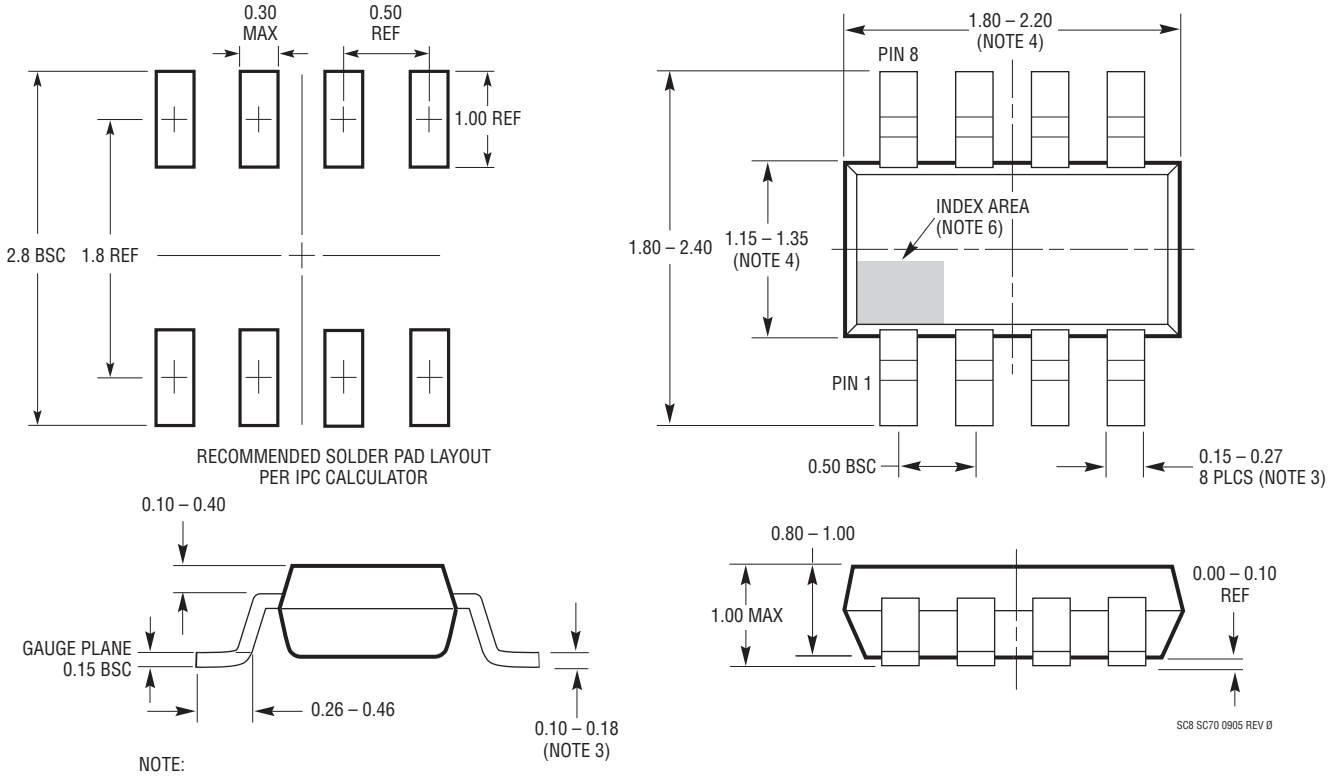


Figure 10. Recommended Layout for N-Channel MOSFET and P-/N-Channel MOSFET Configurations

PACKAGE DESCRIPTION

SC8 Package
8-Lead Plastic SC70
(Reference LTC DWG # 05-08-1639 Rev Ø)

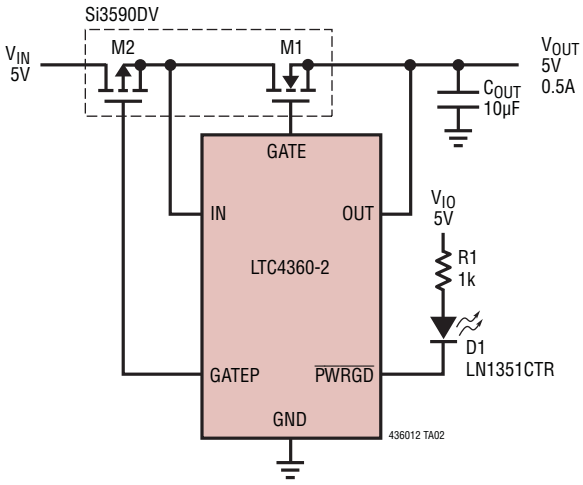


NOTE:
1. DIMENSIONS ARE IN MILLIMETERS
2. DRAWING NOT TO SCALE
3. DIMENSIONS ARE INCLUSIVE OF PLATING
4. DIMENSIONS ARE EXCLUSIVE OF MOLD FLASH AND METAL BURR
5. MOLD FLASH SHALL NOT EXCEED 0.254mm
6. DETAILS OF THE PIN 1 IDENTIFIER ARE OPTIONAL,
   BUT MUST BE LOCATED WITHIN THE INDEX AREA
7. EIAJ PACKAGE REFERENCE IS EIAJ SC-70 AND JEDEC MO-203 VARIATION BA

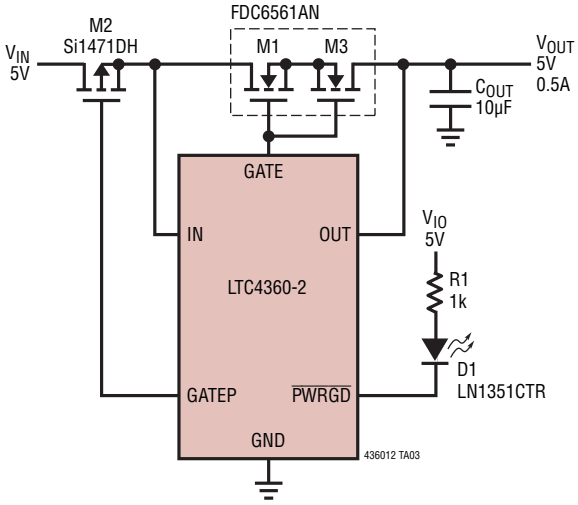
Information furnished by Linear Technology Corporation is believed to be accurate and reliable. However, no responsibility is assumed for its use. Linear Technology Corporation makes no representation that the interconnection of its circuits as described herein will not infringe on existing patent rights.

TYPICAL APPLICATION

5V System Protected from ±24V Power Supplies



5V System Protected from ±24V Power Supplies and Reverse Current



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LTC2935	Ultralow Power Supervisor with Eight Pin-Selectable Thresholds	500nA Quiescent Current, 2mm × 2mm 8-Lead DFN and TSOT-23 Packages
LT3008	20mA, 45V, 3µA I_Q Micropower LDO	280mV Dropout Voltage, Low I_Q: 3µA, V_{IN} = 2.0V to 45V, V_{OUT} = 0.6V to 39.5V; ThinSOT™ and 2mm × 2mm DFN-6 Packages
LT3009	20mA, 3µA I_Q Micropower LDO	280mV Dropout Voltage, Low I_Q: 3µA, V_{IN} = 1.6V to 20V, V_{OUT} = 0.6V to 19.5V; ThinSOT and SC-70 Packages
LTC3576/ LTC3576-1	Switching USB Power Manager with USB OTG + Triple Step-Down DC/DCs	Complete Multifunction PMIC: Bi-Directional Switching Power Manager + 3 Bucks + LDO
LTC4090/ LTC4090-5	High Voltage USB Power Manager with Ideal Diode Controller and High Efficiency Li-Ion Battery Charger	High Efficiency 1.2A Charger from 6V to 38V (60V Max) Input Charges Single Cell Li-Ion Batteries Directly from a USB Port
LTC4098	USB-Compatible Switchmode Power Manager with OVP	High V_{IN}: 38V operating, 60V transient; 66V OVP. 1.5A Max Charge Current from Wall, 600mA Charge Current from USB
LTC4210	Single Channel, Low Voltage Hot Swap™ Controller	Operates from 2.7V to 16.5V, Active Current Limiting, SOT23-6
LTC4213	No R_{SENSE}™ Electronic Circuit Breaker	Controls Load Voltages from 0V to 6V. 3 Selectable Circuit Breaker Thresholds. Dual Level Overcurrent Fault Protection
LT4356	Surge Stopper Overvoltage/Overcurrent Protection Regulator	Wide Operation Range: 4V to 80V. Reverse Input Protection to –60V. Adjustable Output Clamp Voltage
LTC4411	SOT-23 Ideal Diode	2.6A Forward Current, 28mV Regulated Forward Voltage
LTC4412	2.5V to 28V, Low Loss PowerPath™ Controller in ThinSOT	More Efficient than Diode-ORing, Automatic Switching Between DC Sources, Simplified Load Sharing
LTC4413-1/ LTC4413-2	Dual 2.6A, 2.5V to 5.5V Fast Ideal Diodes in 3mm × 3mm DFN	130mΩ On Resistance, Low Reverse Leakage Current, 18mV Regulated Forward Voltage (LTC4413-2 with Overvoltage Protection Sensor)

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LT 0410 • PRINTED IN USA
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